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TECHNOLOGY CENTER 2800

Applicant(s): Heung-Kyu Kwon, Min-Kyo Cho
Assignee: Samsung Electronics Co., Ltd.
Title: Semiconductor Chip Package And Method Of Fabricating The Same
Serial No.: 09/464,322 Filing Date: December 15, 1999
Examiner: Chu, C. Group Art Unit: 2815
Docket No.: AB-881 US

6/A
7-10-01
T. Flower

San Jose, California
June 28, 2001

BOX Non-Fee Amendment
COMMISSIONER FOR PATENTS
Washington, D. C. 20231

RESPONSE TO OFFICE ACTION

Dear Sir:

This is a response to the April 3, 2001 Office Action which has a statutorily shortened period for response that ends July 3, 2001.

Please amend the above-identified application as follows.

IN THE DRAWINGS

Applicants request permission to amend drawing figures 1 and 3 as shown in red ink on the enclosed copies of those figures as filed. A separate request to amend the drawings is enclosed.

IN THE SPECIFICATION

Please amend the paragraphs of the specification as indicated in the mark-up of those paragraphs in Attachment A. The following paragraphs are clean versions of the amended paragraphs.

Please replace the paragraph starting on page 3, line 7 with the following replacement paragraph.

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